SMD POWER COIL
-JNR 4012H-SERIES

## Reliability and Test Condition

| Item | Performance | Test Condition |
| :---: | :---: | :---: |
| Electrical Performance Test |  |  |
| Inductance | Refer to standard electrical characteristics list | HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter |
| RDC |  | CH16502,Agilent33420A Micro-Ohm Meter |
| Saturation Current (Isat) | $\triangle \mathrm{L} \leqq 30 \%$ typical. | Saturation DC Current (Isat) will cause Lo to drop $\triangle \mathrm{L}(\%)$ |
| Heat Rated Current (Irms) | Approximately $\triangle \mathrm{T} \leqq 40^{\circ} \mathrm{C}$ | Heat Rated Current (Irms) will cause the coil temperature rise $\triangle T\left({ }^{\circ} \mathrm{C}\right)$ without core loss. <br> 1.Applied the allowed DC current(keep 1 min.) <br> 2.Temperature measured by digital surface thermometer |
| Operating Temperature | $-40^{\circ} \mathrm{C} \sim+125^{\circ} \mathrm{C}$ (Including self - temperature rise) |  |
| Storage Temperature | $-40 \sim+125^{\circ} \mathrm{C}$ (on board) |  |
| Reliability Test |  |  |
| Life Test | Appearance : No damage Inductance : within $\pm 10 \%$ of initial value Q : Shall not exceed the specification value RDC : within $\pm 15 \%$ of initial value and shall not exceed the specification value | Preconditioning: Run through IR reflow for 2 times. <br> ( IPC/JEDEC J-STD-020D Classification Reflow Profiles) <br> Temperature : $125 \pm 2^{\circ} \mathrm{C}$ (Inductor) <br> Applied current : rated current <br> Duration : 1000 $\pm 12$ hrs <br> Measured at room temperature after placing for $24 \pm 2$ hrs |
| Load Humidity |  | Preconditioning: Run through IR reflow for 2 times. <br> ( IPC/JEDEC J-STD-020D Classification Reflow Profiles) <br> Humidity : $85 \pm 2 \%$ R.H <br> Temperature : $85^{\circ} \mathrm{C} \pm 2^{\circ} \mathrm{C}$ <br> Duration: 1000hrs Min. with $100 \%$ rated current <br> Measured at room temperature after placing for $24 \pm 2$ hrs |
| Moisture Resistance |  | Preconditioning: Run through IR reflow for 2 times. <br> ( IPC/JEDEC J-STD-020D Classification Reflow Profiles) <br> 1. Baked at $50^{\circ} \mathrm{C}$ for 25 hrs , measured at room temperature after placing for 4 hrs. <br> 2. Raise temperature to $65 \pm 2^{\circ} \mathrm{C} 90-100 \% \mathrm{RH}$ in 2.5 hrs , and keep 3 hours, cool down to $25^{\circ} \mathrm{C}$ in 2.5 hrs. <br> 3. Raise temperature to $65 \pm 2^{\circ} \mathrm{C} 90-100 \% \mathrm{RH}$ in 2.5 hrs , and keep 3 hours, cool down to $25^{\circ} \mathrm{C}$ in 2.5 hrs , keep at $25^{\circ} \mathrm{C}$ for 2 hrs then keep at $-10^{\circ} \mathrm{C}$ for 3 hrs <br> 4. Keep at $25^{\circ} \mathrm{C} 80-100 \% \mathrm{RH}$ for 15 min and vibrate at the frequency of 10 to 55 Hz to 10 Hz , measure at room temperature after placing for $1 \sim 2$ hrs. |
| Thermal shock |  | Preconditioning: Run through IR reflow for 2 times. <br> ( IPC/JEDEC J-STD-020D Classification Reflow Profiles) <br> Condition for 1 cycle <br> Step1 : $-40 \pm 2^{\circ} \mathrm{C} 30 \pm 5 \mathrm{~min}$ <br> Step2: $25 \pm 2^{\circ} \mathrm{C} \leqq 0.5$ min <br> Step3: $125 \pm 2^{\circ} \mathrm{C} 30 \pm 5 \mathrm{~min}$ <br> Number of cycles : 500 <br> Measured at room temperature after placing for $24 \pm 2$ hrs |
| Vibration |  | Oscillation Frequency: $10 \sim 2 \mathrm{~K} \sim 10 \mathrm{~Hz}$ for 20 minutes <br> Equipment: Vibration checker <br> Total Amplitude: $1.52 \mathrm{~mm} \pm 10 \%$ <br> Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) |

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| Reliability Test | Mildly activated rosin fluxes are preferred. JANTEK terminations are suitable for all wave and <br> re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the <br> utilization of hot air soldering tools. |  |
| Lead Free Solder <br> re-flow: | Recommended temperature profiles for re-flow soldering in Figure 1. |  |
|  | Products attachment with a soldering iron is discouraged due to the inherent process control limitations. <br> If a soldering iron must be employed the following precautions are recommended. for Iron Soldering <br> in Figure 2. <br> Note : <br> Soldering Iron: <br> • Nreheat circuit and products to $150^{\circ} \mathrm{C}$ |  |



